TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSVI)

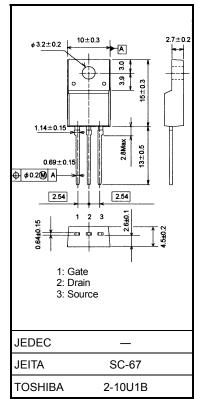
2SK3567

Switching Regulator Applications

- Low drain-source ON resistance: $RDS(ON) = 1.7 \Omega$ (typ.)
- High forward transfer admittance: $|Y_{fs}| = 2.5S$ (typ.)
- Low leakage current: $IDSS = 100 \ \mu A (VDS = 600 V)$
- Enhancement mode: $V_{th} = 2.0 \sim 4.0 \text{ V} (V_{DS} = 10 \text{ V}, \text{ ID} = 1 \text{ mA})$

Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V _{DSS}	600	V	
Drain-gate voltage (F	R _{GS} = 20 kΩ)	V _{DGR}	600	V	
Gate-source voltage		V _{GSS}	±30	V	
Drain current	DC (Note 1)	ID	3.5		
	Pulse (t = 1 ms) (Note 1)	I _{DP}	14	A	
Drain power dissipati	on (Tc = 25°C)	PD	35	W	
Single pulse avalance	he energy (Note 2)	E _{AS}	201	mJ	
Avalanche current		I _{AR}	3.5	А	
Repetitive avalanche	energy (Note 3)	E _{AR}	3.5	mJ	
Channel temperature	•	T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55~150	°C	



Weight: 1.7 g (typ.)

Thermal Characteristics

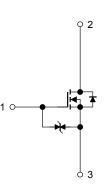
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	3.57	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	62.5	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: $V_{DD} = 90 \text{ V}, \text{ T}_{ch} = 25^{\circ}\text{C}(\text{initial}), \text{ L} = 28.8 \text{ mH}, \text{ I}_{AR} = 3.5 \text{ A}, \text{ R}_{G} = 25 \Omega$

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Please handle with caution.



Unit: mm

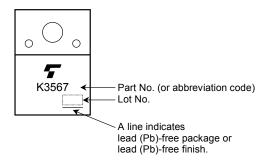
Electrical Characteristics (Ta = 25°C)

Chara	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I _{GSS}	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μA
Gate-source brea	akdown voltage	V (BR) GSS	$I_G=\pm 10~\mu A,~V_{DS}=0~V$	±30	_	—	V
Drain cut-off current		I _{DSS}	$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		_	100	μA
Drain-source breakdown voltage		V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	600	_		V
Gate threshold voltage		V _{th}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$	2.0	_	4.0	V
Drain-source ON	Drain-source ON resistance $R_{DS(ON)}$ $V_{GS} = 10 \text{ V}, \text{ I}_{D} =$		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 1.8 \text{ A}$	_	1.7	2.2	Ω
Forward transfer admittance		Y _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1.8 \text{ A}$	0.7	2.5	_	S
Input capacitance		C _{iss}	$V_{DS} = 25 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$		550	—	pF
Reverse transfer capacitance		C _{rss}			6	_	
Output capacitance		C _{oss}			60		
Switching time	Rise time	tr	$\begin{array}{c} 10 \text{ V} \\ \text{V}_{GS} \\ 0 \text{ V} \\ 50 \Omega \\ \end{array} \begin{array}{c} \text{I}_{D} = 1.8 \text{ A} \\ \text{V}_{OUT} \\ \text{V}_{OUT} \\ \text{V}_{DD} \\ \text{V}_{D} \\ \text{V}_{DD} \\ \text{V}_{DD} \\ \text{V}_{DD} \\ \text{V}_{DD} \\ \text{V}_{DD} \\ \text{V}_{D} \\ \text{V}_{DD} \\ \text{V}_{D} \\ \text$	_	12		ns
	Turn-on time	t _{on}		_	45	_	
	Fall time	t _f			13	_	
	Turn-off time	t _{off}		_	80	_	
Total gate charge		Qg		_	16	—	
Gate-source charge		Q _{gs}	$V_{DD} \simeq 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 3.5 \text{ A}$	_	10		nC
Gate-drain charge		Q _{gd}	1	_	6	—	

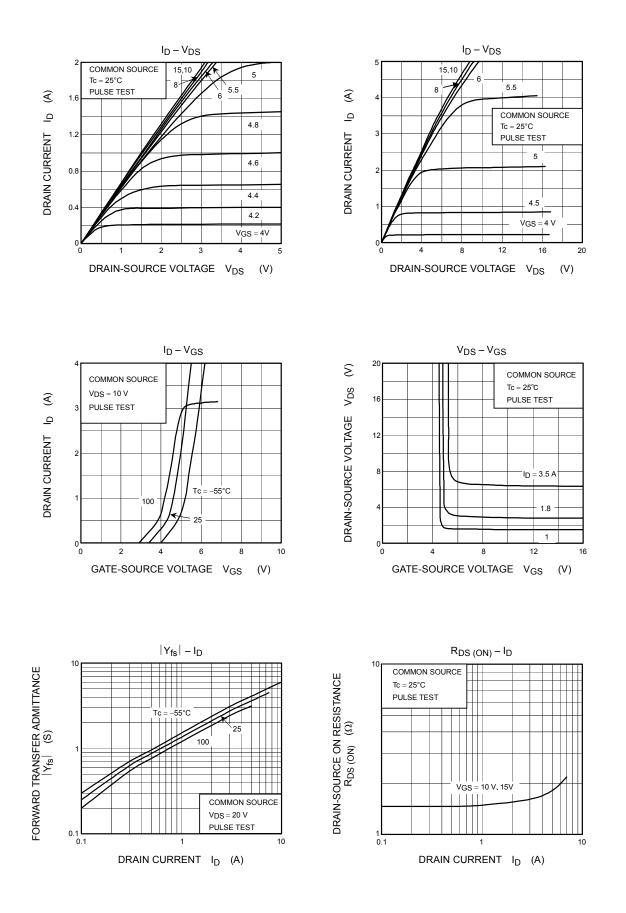
Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	—	_	_	3.5	A
Pulse drain reverse current (Note 1)	I _{DRP}	—	_	_	14	А
Forward voltage (diode)	V _{DSF}	$I_{DR} = 3.5 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	-1.7	V
Reverse recovery time	t _{rr}	$I_{DR} = 3.5 \text{ A}, V_{GS} = 0 \text{ V},$	_	1400	_	ns
Reverse recovery charge	Q _{rr}	dI _{DR} /dt = 100 A/μs		9.0		μC

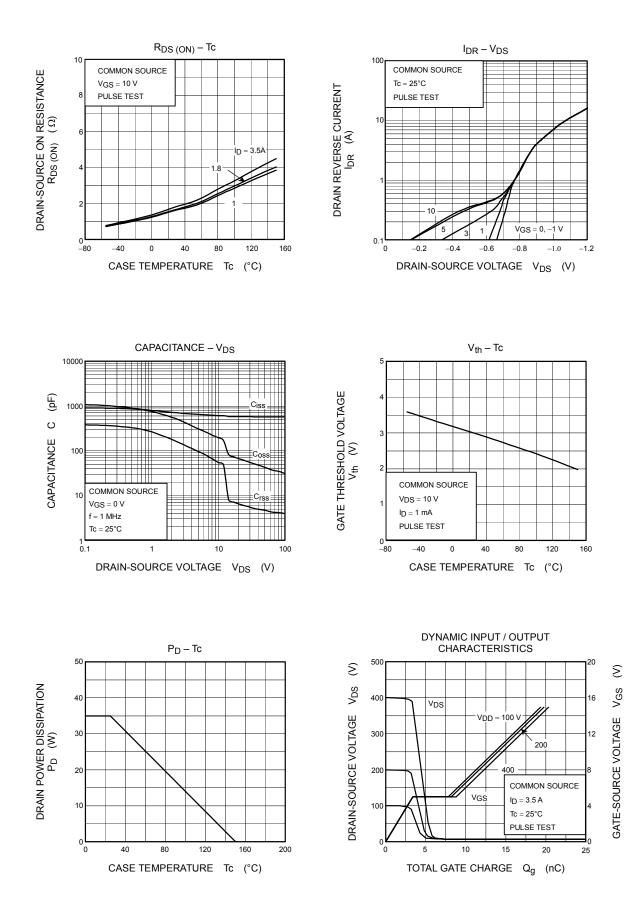
Marking

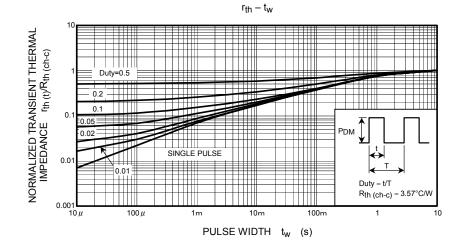


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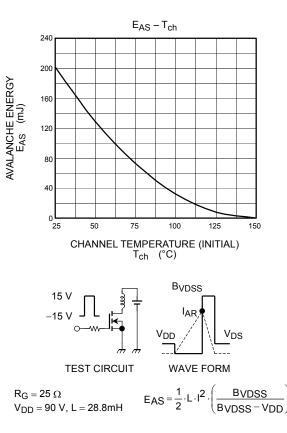


TOSHIBA





SAFE OPERATING AREA 100 ١D (PULSED) E 10 100 µs ₽ ID max (CONTINUOUS) 1 ms DRAIN CURRENT DC OPERATION $Tc = 25^{\circ}C$ 0.1 * SINGLE NONREPETITIVE PULSE Tc=25°C CURVES MUST BE DERATED LINEARLY WITH INCREASE IN VDSS max TEMPERATURE. 0.01 10 100 1000 1 DRAIN-SOURCE VOLTAGE VDS (V)



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